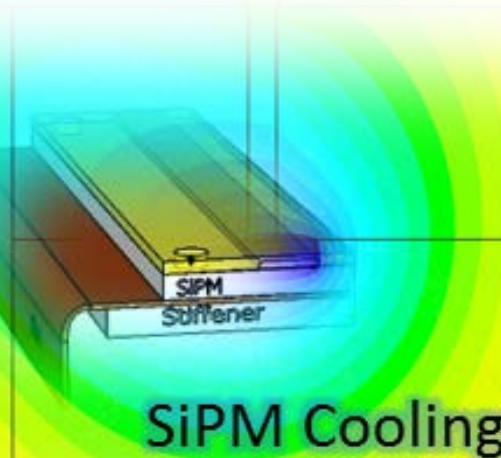


SiPM cooling: requirements, challenges, options

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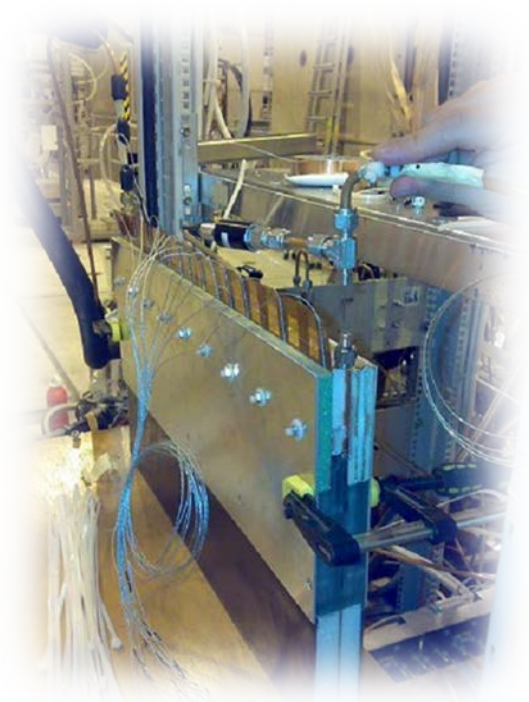


1st Workshop on SiPM cooling for Fiber Tracker, CERN 17 October 2013


Current status

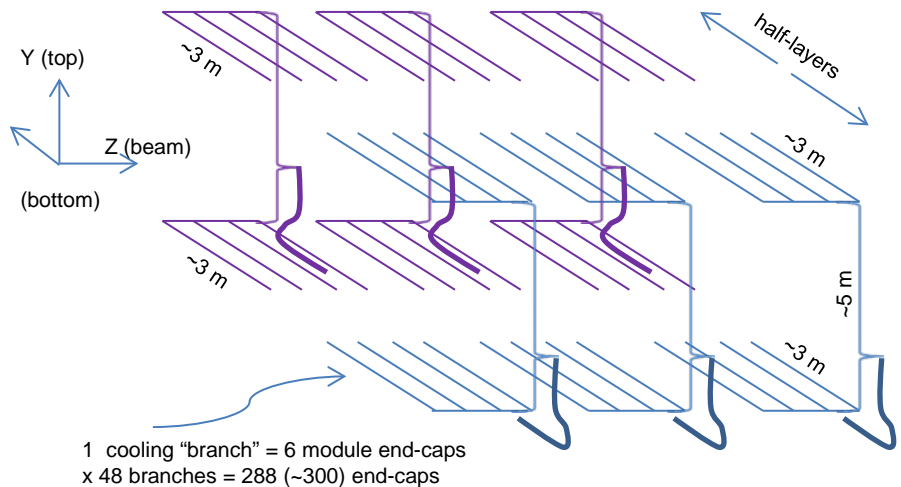
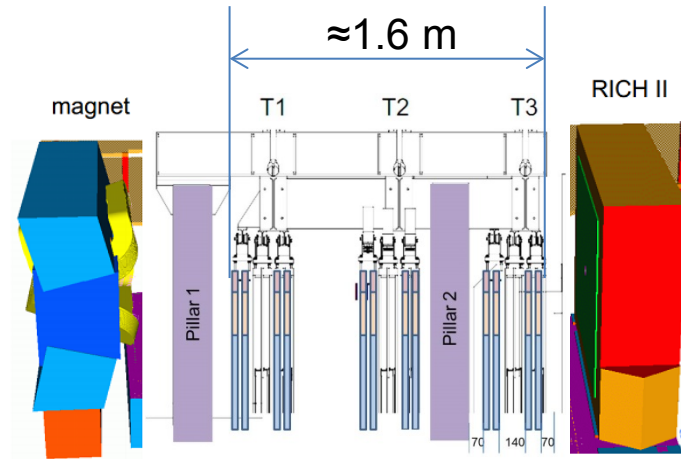
- Requirements (see the attached “Draft Specs...”): stable
- Thermal simulation project with EN-CV-PJ (E. Da Riva): ongoing since March 2013
- Cooperation with the CTU (Prague) group led by V. Vacek: summer 2013 tests of the chilled air and 2-phase (C_3F_8) cooling options with the FT end-cap mockups
- Participation in end cap design (consultancy)
- Two full-scale end cap mockups were made
- Contacts with the industry: Ferrotec NORD (RU), ITE (UA), Thermacore (UK), Korund Albion Ltd (UK), HYDRO Aluminum (DK)
- Initial liquid (C_6F_{14}) cooling test with the “mockup#2”

The activity is supported by CERN PH-LBO, but no LHCb groups assumed a commitment, yet...



What's to be cooled?

- **3 stations** (with half-stations moving apart); station = 4 layers; 1 layer = 12 modules
- $12 * 12 = 144$ modules * 2 (top/bottom) = **288 end caps**;
- 1 end cap: **53 cm (X)** x **20 cm (Y)** x **4 cm (Z)**; contains an array of **16 SiPMs**
- Total length of SiPM arrays: \approx **150 m**
- 1 cooling “branch” = 6 consecutive end caps (\approx 3 m); **48 branches** 
- **No encapsulating gas volumes!** End caps are exposed to the cavern ambient air (nominal: $T=20C$, dew point 10-12C)
- Heat load: **$O(10W/module)$** , dominated by parasitic heat influx (w/o heat pick-up in all lines!). Total: **3 kW 6 kW + 20...25% (lines)**



Big extent, no encapsulation

Requirements (I)

- **-40°C...-50°C** : SiPM dark noise!
 - increases 50...100 fold upon neutron irradiation (50 fb^{-1})
 - decreases 2-fold at every 10°C of cooling, thus +20°C -> -40°C by the end of lifetime
 - Most important for inner modules ($|x| < 1 \text{ m}$)
 - A design margin (down to -50°C) is required, too
- **Temperature uniformity in space** : SiPM gain adjustability
 - SiPM as a whole: common gain adjustment, broad range;
 - channel-by-channel within SiPM: no adjustment -> $\pm 0.5 \text{ }^\circ\text{C} / 33 \text{ mm}$
 - A gradient of up to 10°C over 3 m is tolerable (but cool inner modules first!)
- **Condensation, frost formation**
 - Keep all external surfaces above a local dew point
 - Internal spaces (SiPM enclosure) : flushing with dry (pre-cooled?) gas
 - consider external gas envelope around end caps?
- **Modularity**
 - Every end cap has its own cooling structure (e.g., no common cooling pipe for 6 modules)
 - SiPMs should be accessible for maintenance

Requirements (II)

- **Temperature uniformity in time :**
 - SiPM gain affects the detection efficiency (should be constant at 98-99%)
 - Different for G(T) for Hamamatsu and KETEC SiPMs
 - HAMAMATSU: $\pm 1^\circ\text{C}$ between calibrations (LHC fills?)
- **Cooling power: 3...6 kW (+20...25% for lines)**
 - Dominant heat load: parasitic influx through end cap insulation, flex PCB and fibres
 - Simulation: $O(10\text{W})$ per end cap, without in/out lines
 - tests (with loose in/out insulation) indicated $< 20\text{W}$
 - $20\text{ W} \times 300$ end caps = 6 kW, plus heat pick up in transfer/connections
- **(some) radiation hardness: $\sim 50\text{ Gy}$, $\sim 10^{12}$ neutrons/cm² (1 MeV)**
 - Peltier modules (?)
 - Refrigerants beyond traditional pFC? Candidate: HFC (e.g. R125, C2F5H)
- **Anti-requirement: no concerns about material budget**
 - Unlike with IDs, can use materials like copper, steel, PC

Requirements (III, see the “Specs”)

- Thermal expansion matching (CTE: PC=70 ppm, Alu=23 ppm)
- No rigid cooling/SiPM junctions (only sliding or elastic)
- No “dirty”, non-volatile, non-dielectric fluids (Si oils, brines...)
- No interference with r/o electronics (connections at the end cap sides)
- Remote cooling plant/power supplies: ~70 m away
- No electro-mechanical appliances near the detector (fans, pumps etc)
- 6 “caterpillar” sections
- SiPM cooling should be insensitive to 3...5° inclination (U-/V- layers)
- Cooling/annealing cycling (heating up to +40°C should be foreseen)
- Preferences (apart from **low cost**):
 - Environmentally-friendly solution
 - Warm (above dew point) connections only
 - Maximal use of existing infrastructures (mixed/chilled water, C6F14 transfer lines)



Challenges

- Operating a 150 m long SiPM array, at -40°C or below, within 40 mm enclosures, without external dry gas volume
- Upgraded OT should fit into the space envelope of the existing tracker, not intended for sub-zero cooling (tight gaps!)
- Distribution/manifolding: $300 \times 2 = 600$ inlets and outlets, over twelve 5×6 m² planes
- “Elastic” insulation of the module edges
- Long-term stability of the thermal interfaces between SiPMs and the cooling structures (silicone thermal pads? metal foams?)
- Cost

Cooling technologies, options (I)

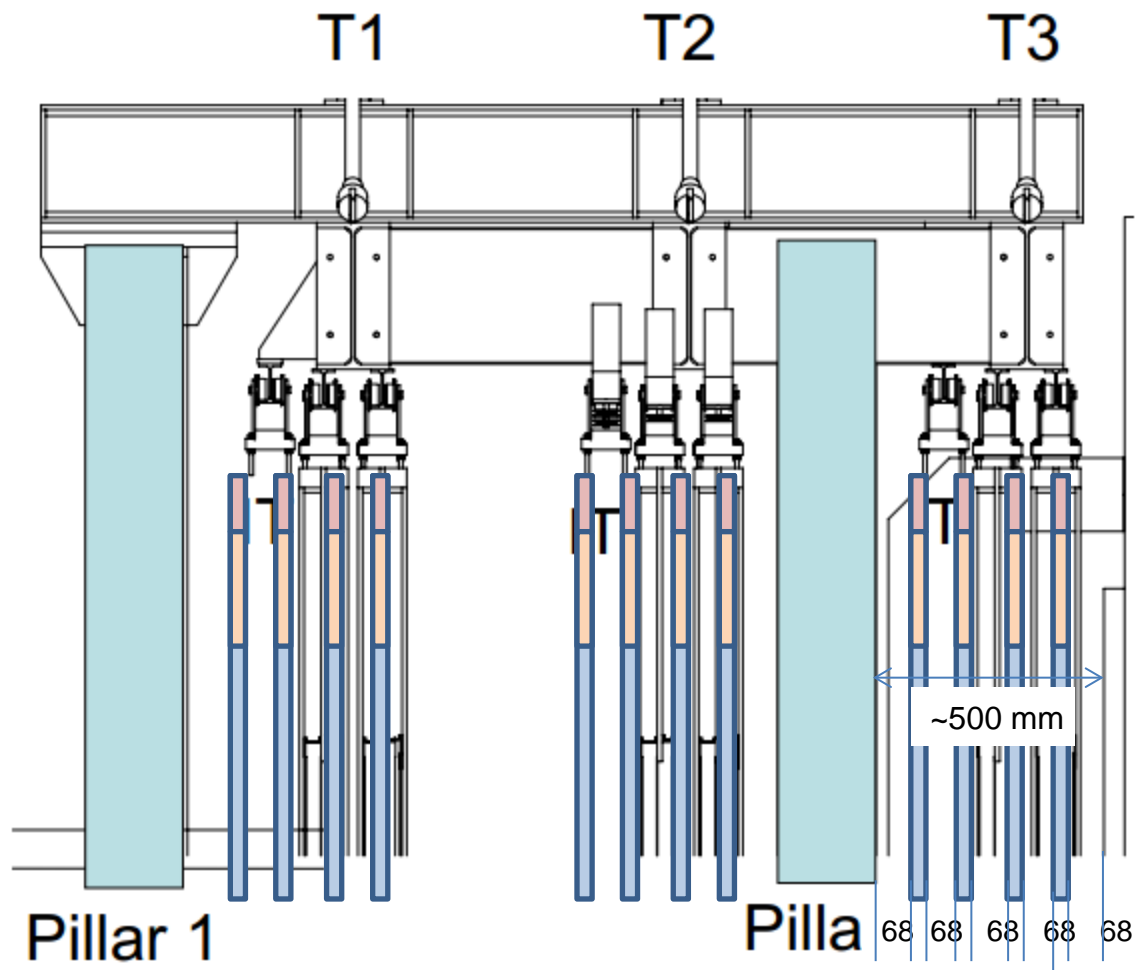
- Plain mono-phase liquid cooling (see Enrico's talk)
 - So far baseline choice, widely used at CERN, established technology, COTC components
 - Big reserve in cooling power, permits serial module connection
 - Naturally permits annealing by warming-up
 - In clash with the requirements of low-occupancy, preferred warm connections
 - >600 potential leaks
 - C6F14 (a usual choice): expensive, high GWP, oil-free pump
 - Low-loss transfer lines can be expensive (70 m, two-way)
- 2-phase (evaporative) cooling (Vic, Greg, Bart)
 - Established technology, widely used at CERN,
 - Enormous reserve in cooling power, permits serial connections
 - Potentially permits warm-only connections (with local vapor heaters)
 - Possibly, can use commercial “green” refrigerants (e.g., HFC-125)
 - -40...-50 °C – too low for refrigerants commonly used at CERN (C3F6, CO2)
 - More difficult to control and equalize temperature (“Ferrari with breaks only”)
 - For annealing, an extra heater will be needed
 - More stuff inside end caps (in case of local pre-cooling and heating)

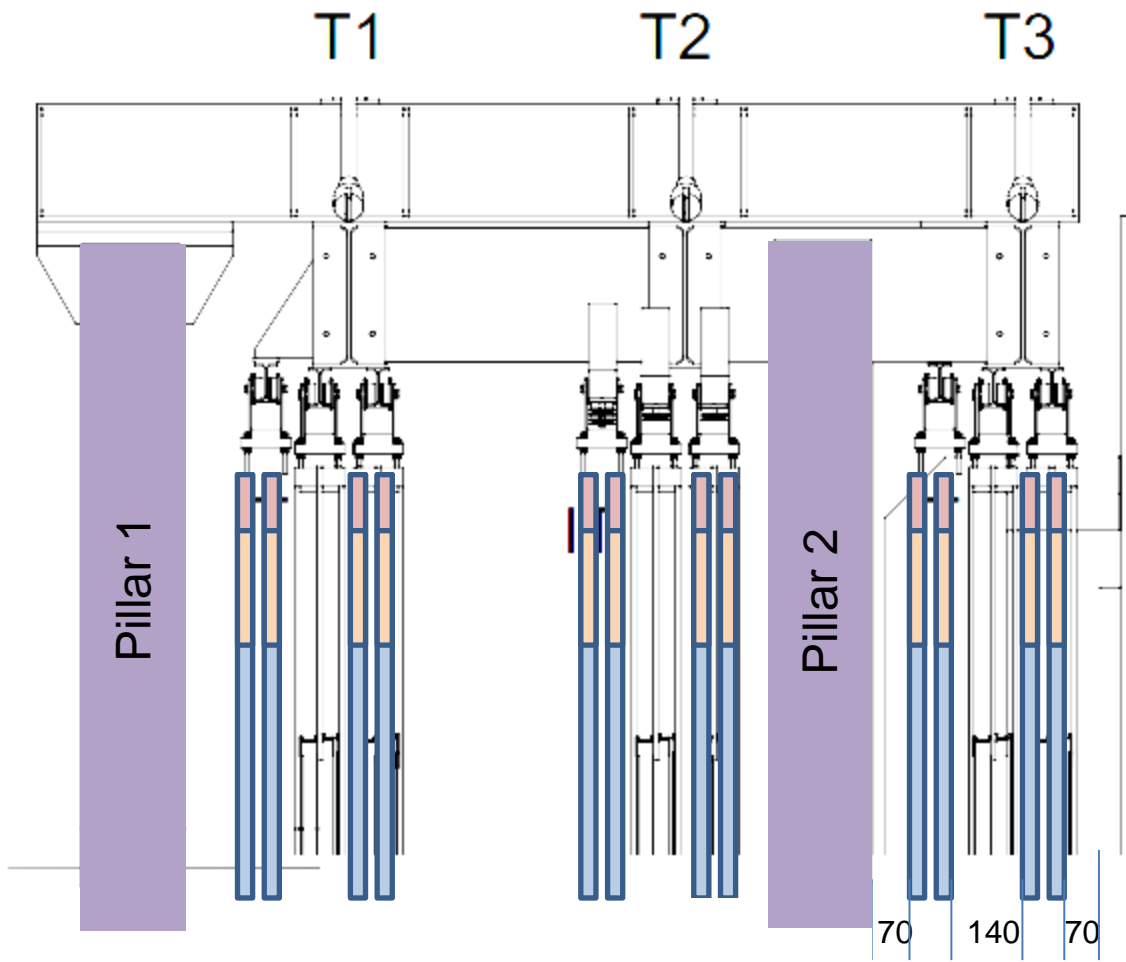
Cooling technologies, options (II)

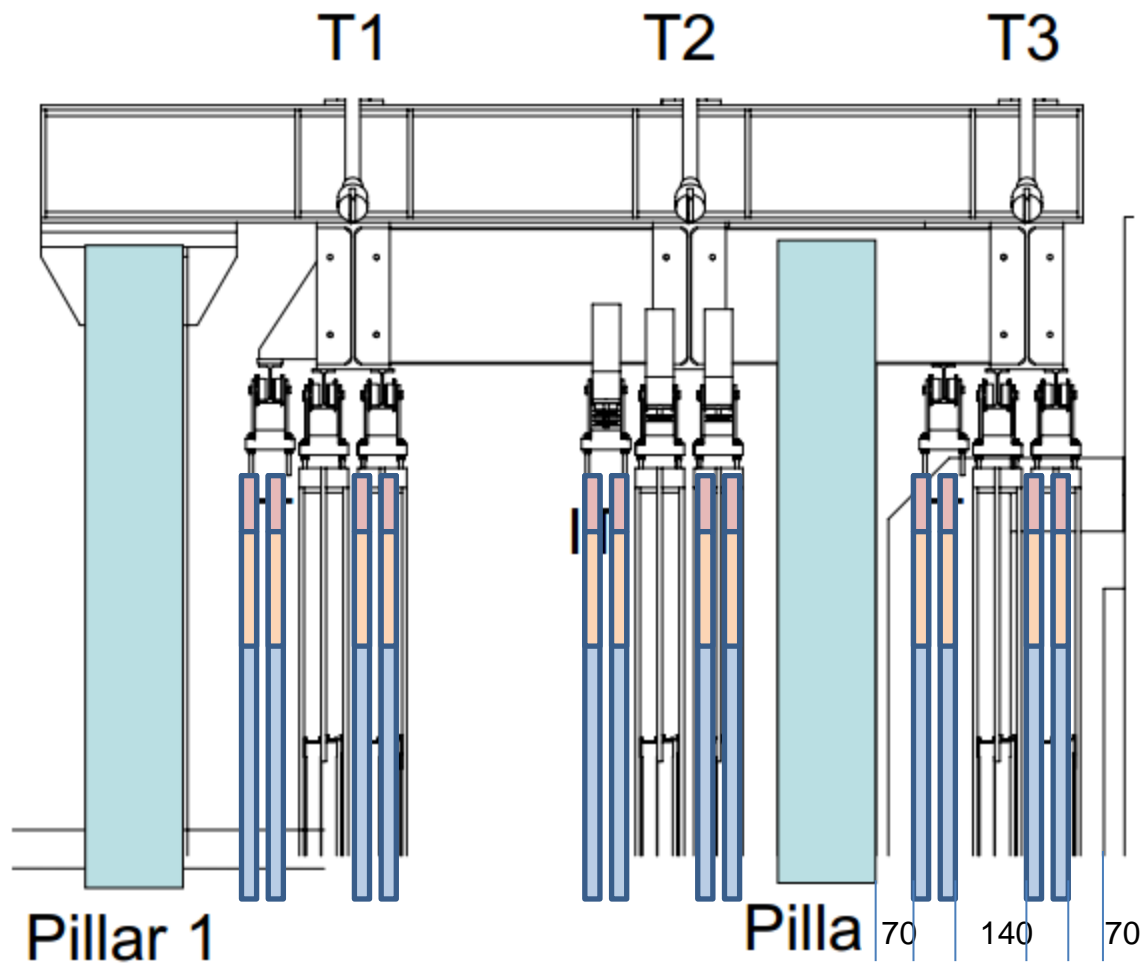
- Chilled air (Vic)
 - Demonstrated to work with SciFi mockups; 100% non-polluting
 - Naturally permits annealing by warming-up
 - Potentially, voids the problem of thermal interface (radiators can be glued to SiPMs)
 - no reserve in cooling power
 - Steep temperature gradient, serial connections are impossible
 - Attractive only if the cooler (vortex tube) is integrated in the end cap
 - Not as “green” as it looks: requires enormous amount of dry compressed air, $O(10^4 \text{ m}^3/\text{h})$ for 300 end caps (efficiency: <20%)
- Thermo-electric or hybrid (Petr)
 - Historically the earliest proposed option
 - Widely used for compact cooling systems (a single end cap?)
 - Ideal modular solution, with “warm-only” connections
 - Stability under neutron irradiation??
 - Low efficiency for high ΔT (at best $\sim 10\%$ for ΔT of $70 \text{ }^\circ\text{C}$) – require 30...60kW w/cooling
 - Can be expensive (linear floating power supplies, $\sim 1200 \sim 30\text{W}$ channels)
 - Hybrid solutions (e.g., with low-T heat pipes) require R&D

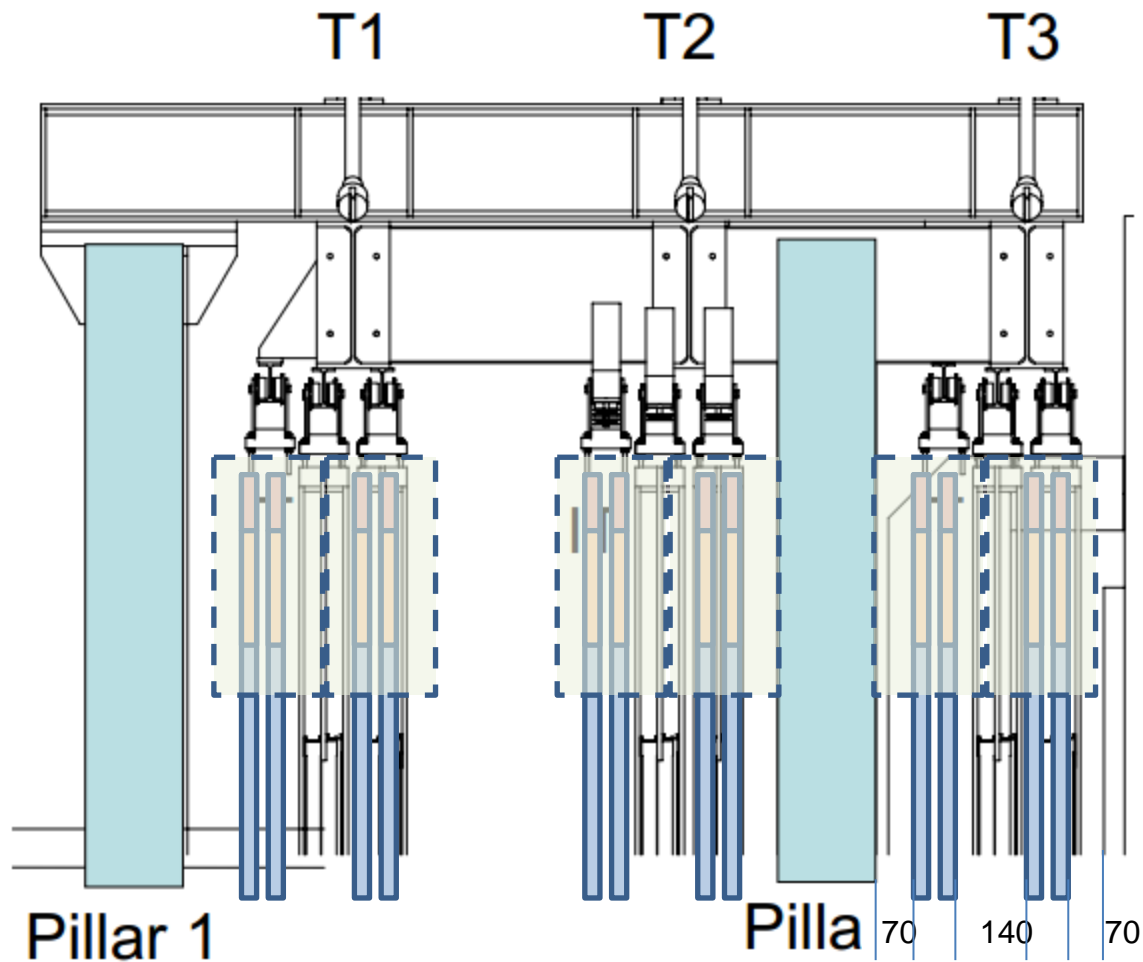
Summary

- No cooling solution wins in all categories, so some more constraints are needed to make the choice...
- A non-scientific wisdom: *the simple things in life are best!...* So, maybe the missing bit is just **make it as simple as possible...**
- ...but not simpler.









Ideally, there should be “gas envelopes” flushed with dry gas around the end caps, like with all deep-cooled detectors. This would be a radical solution to a humidity condensation and the edge insulation problems. Real-life solutions should represent approximations to this approach.

